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If you have any questions related to the data sheet, please contact our nearest sales office (details via http://www.ampleon.com/sales).

Thank you for your cooperation and understanding,

Ampleon

BLF246

FEATURES

- · High power gain
- · Low noise figure
- · Easy power control
- · Good thermal stability
- · Withstands full load mismatch.

APPLICATIONS

 Large signal amplifier applications in the VHF frequency range.

DESCRIPTION

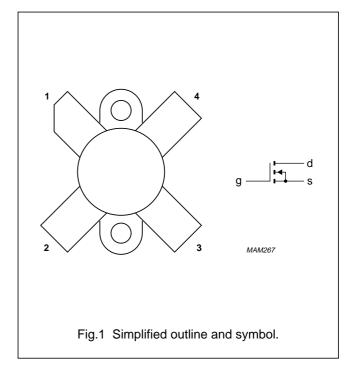
Silicon N-channel enhancement mode vertical D-MOS transistor encapsulated in a 4-lead, SOT121B flange package with a ceramic cap. All leads are isolated from the flange. A marking code, showing gate-source voltage (V_{GS}) information is provided for matched pair applications. Refer to the "General" section of the handbook for further information.

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

PINNING - SOT121B

PIN	DESCRIPTION
1	drain
2	source
3	gate
4	source



QUICK REFERENCE DATA

RF performance at $T_h = 25$ °C in a common source test circuit.

MODE OF OPERATION	f	V _{DS}	P _L	G _p	η _D
	(MHz)	(V)	(W)	(dB)	(%)
CW, class-B	108	28	80	≥16	≥55

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

VHF power MOS transistor

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LIMITING VALUES

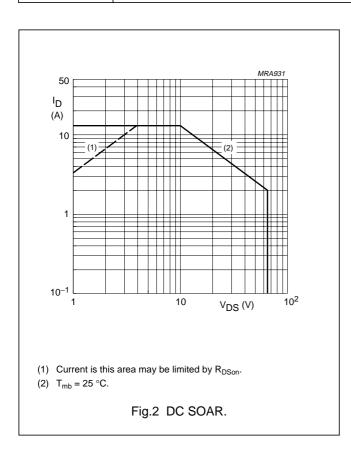
In accordance with the Absolute Maximum System (IEC 60134).

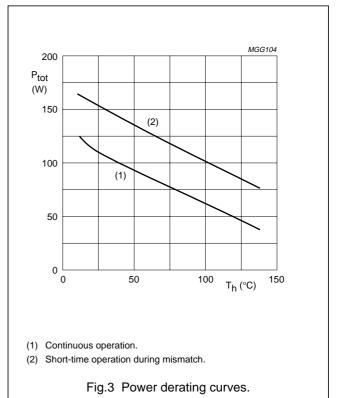
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		_	65	V
V_{GS}	gate-source voltage		_	±20	V
I _D	DC drain current		_	13	А
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	130	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	200	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	1.35	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	0.2	K/W

3





2003 Aug 05

Downloaded from Arrow.com.

VHF power MOS transistor

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CHARACTERISTICS

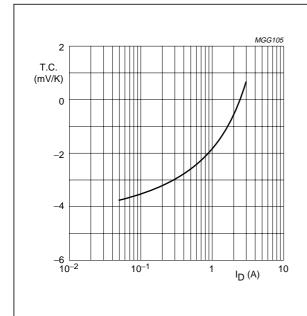
 $T_j = 25$ °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	V _{GS} = 0; I _D = 50 mA	65	_	_	V
I _{DSS}	drain-source leakage current	V _{GS} = 0; V _{DS} = 28 V	_	_	2.5	mA
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$	_	_	1	μΑ
V _{GSth}	gate-source threshold voltage	I _D = 50 mA; V _{DS} = 10 V	2	_	4.5	V
ΔV_{GS}	gate-source voltage difference of matched pairs	$I_D = 50 \text{ mA}; V_{DS} = 10 \text{ V}$	_	_	100	mV
9fs	forward transconductance	I _D = 2.5 A or 5 A; V _{DS} = 10 V	3	4.2	_	S
R _{DSon}	drain-source on-state resistance	I _D = 5 A; V _{GS} = 10 V	_	0.2	0.3	Ω
I _{DSX}	on-state drain current	V _{GS} = 10 V; V _{DS} = 10 V	_	22	_	Α
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	225	_	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	180	_	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	25	_	pF

V_{GS} group indicator

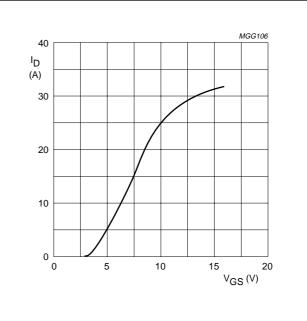
GROUP		IITS V)	GROUP	LIMITS (V)		
	MIN.	MAX.		MIN.	MAX.	
А	2.0	2.1	0	3.3	3.4	
В	2.1	2.2	Р	3.4	3.5	
С	2.2	2.3	Q	3.5	3.6	
D	2.3	2.4	R	3.6	3.7	
E	2.4	2.5	S	3.7	3.8	
F	2.5	2.6	Т	3.8	3.9	
G	2.6	2.7	U	3.9	4.0	
Н	2.7	2.8	V	4.0	4.1	
J	2.8	2.9	W	4.1	4.2	
K	2.9	3.0	Х	4.2	4.3	
L	3.0	3.1	Y	4.3	4.4	
М	3.1	3.2	Z	4.4	4.5	
N	3.2	3.3				

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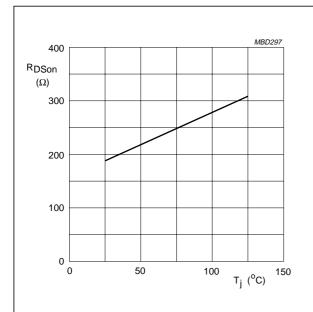
 V_{DS} = 10 V; valid for T_h = 25 to 70 °C.

Fig.4 Temperature coefficient of gate-source voltage as a function of drain current; typical values.



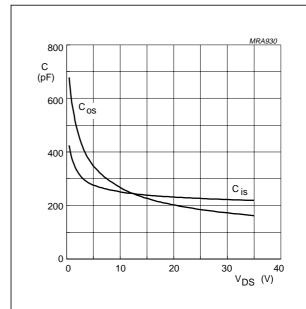
 $V_{DS} = 10 \text{ V}; T_j = 25 ^{\circ}\text{C}.$

Fig.5 Drain current as a function of gate-source voltage; typical values.



 $V_{GS} = 10 \text{ V}; I_D = 5 \text{ A}.$

Fig.6 Drain-source on-state resistance as a function of junction temperature; typical values.

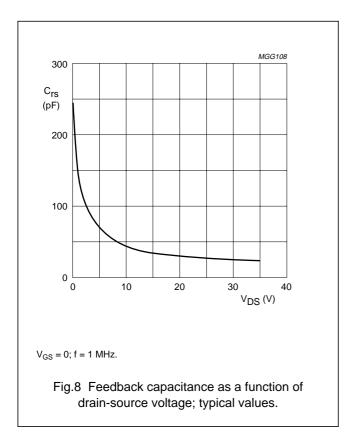


 $V_{GS} = 0$; f = 1 MHz.

Fig.7 Input and output capacitance as functions of drain-source voltage; typical values.

VHF power MOS transistor

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APPLICATION INFORMATION

RF performance in CW operation in a common source test circuit.

 T_h = 25 °C; $R_{th\ mb\text{-}h}$ = 0.2 K/W; R_{GS} = 12 Ω unless otherwise specified.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _D (A)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	108	28	0.1	80	>16	>55
CW, class-B	108	28	0.1	80	typ. 18	typ. 65
CW, class-C	108	28	0 ⁽¹⁾	80	typ. 15	typ. 72

Note

1. $V_{GS} = 0$ (class-C).

Ruggedness in class-B operation

The BLF246 is capable of withstanding a load mismatch corresponding to VSWR = 50: 1 through all phases under the following conditions: V_{DS} = 28 V; f = 108 MHz; T_h = 25 °C; $R_{th\ mb-h}$ = 0.2 K/W at rated output power.

Noise figure

Measured with 80 W power-matched source and load in the test circuit (see Fig.9) with V_{DS} = 28 V; I_D = 2 A; f = 108 MHz; R_{GS} = 27 Ω ; T_h = 25 °C; $R_{th\ mb-h}$ = 0.2 K/W; F = typ. 3 dB.

VHF power MOS transistor

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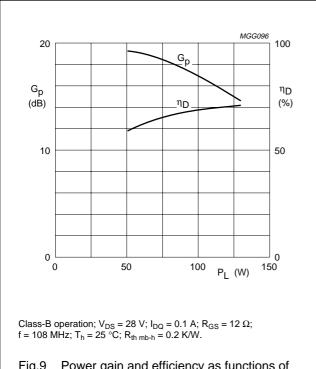
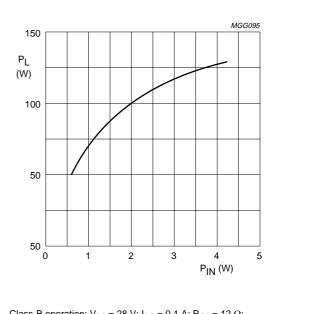
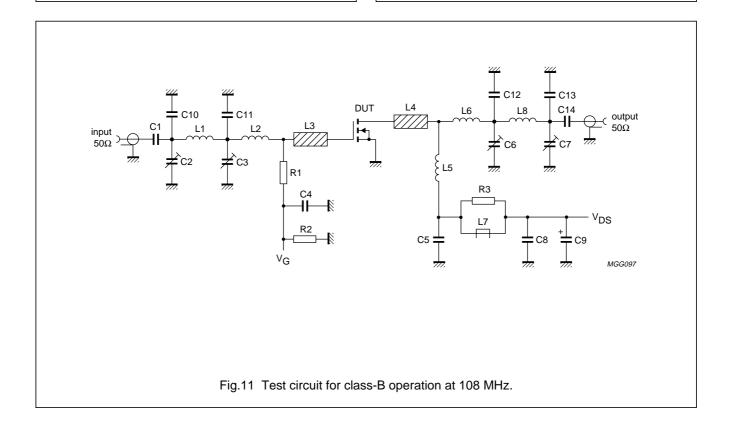


Fig.9 Power gain and efficiency as functions of load power; typical values.



Class-B operation; V_{DS} = 28 V; I_{DQ} = 0.1 A; R_{GS} = 12 Ω ; f = 108 MHz; T_h = 25 °C; R_{th mb-h} = 0.2 K/W.

Fig.10 Load power as a function of input power; typical values.



VHF power MOS transistor

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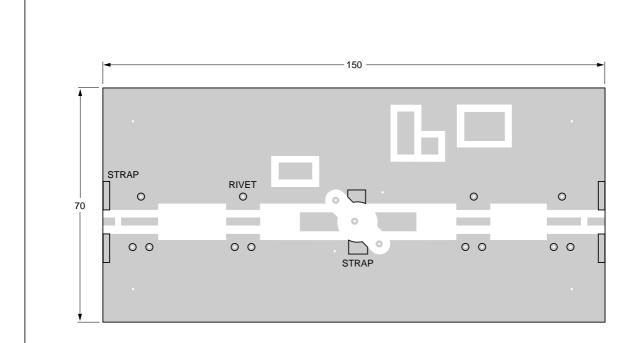
List of components (see Figs 11 and 12).

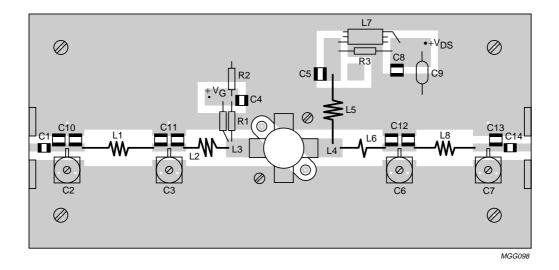
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C4, C5, C8, C14	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C2, C3, C6, C7	film dielectric trimmer	5 to 60 pF		2222 809 08003
C9	electrolytic capacitor	2.2 μF, 63 V		2222 030 38228
C10	multilayer ceramic chip capacitor; note 1	68 pF + 39 pF in parallel		
C11	multilayer ceramic chip capacitor; note 1	69 pF + 100 pF in parallel		
C12	multilayer ceramic chip capacitor; note 1	2x 100 pF in parallel		
C13	multilayer ceramic chip capacitor; note 1	62 pF		
L1	5 turns enamelled 0.6 mm copper wire	52 nH	length 6.5 mm int. dia. 3 mm leads 2 × 10 mm	
L2	2 turns enamelled 0.6 mm copper wire	19 nH	length 3.5 mm int. dia. 3 mm leads 2 × 7.5 mm	
L3, L4	stripline; note 2	31 Ω	length 13 mm width 6 mm	
L5	3 turns enamelled 1.6 mm copper wire	36 nH	length 12 mm int. dia. 6 mm leads 2 × 5 mm	
L6	hairpin of enamelled 1.6 mm copper wire	14 nH	length 20 mm	
L7	grade 3B Ferroxcube HF choke			4312 020 36640
L8	3 turns enamelled 1.6 mm copper wire	52 nH	length 8 mm int. dia. 6 mm leads 2 × 9 mm	
R1	metal film resistor	$2 \times 24~\Omega$ in parallel, 0.4 W		
R2	metal film resistor	100 kΩ, 0.4 W		
R3	metal film resistor	10 Ω, 0.4 W		

Notes

- 1. American Technical Ceramics capacitor, type 100B or other capacitor of the same quality.
- 2. The striplines are mounted on a double copper-clad PCB with epoxy fibre-glass dielectric (ϵ_r = 4.5), thickness 1.6 mm.

BLF246



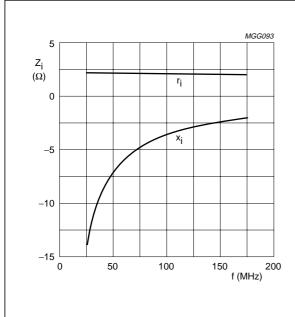


Dimensions in mm.

The circuit and components are situated on one side of the epoxy fibre-glass board, the other side being fully metallized to serve as a ground. Earth connections are made by means of hollow rivets, whilst under the source leads, copper straps are used for a direct contact between the upper and lower sheets.

Fig.12 Component layout for 108 MHz class-B test circuit.

BLF246



Class-B operation; V_DS = 28 V; I_DQ = 0.1 A; R_GS = 12 Ω ; P_L = 80 W; T_h = 25 °C; R_{th mb-h} = 0.2 K/W.

Fig.13 Input impedance as a function of frequency (series components); typical values.

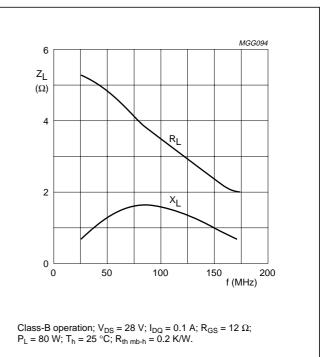
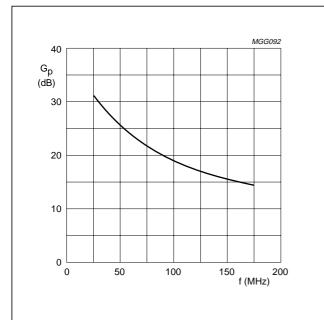


Fig.14 Load impedance as a function of frequency (series components); typical values.



Class-B operation; V_{DS} = 28 V; I_{DQ} = 0.1 A; R_{GS} = 12 Ω ; P_L = 80 W; T_h = 25 °C; R_{th mb-h} = 0.2 K/W.

Fig.15 Power gain as a function of frequency; typical values.

VHF power MOS transistor

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BLF246 scattering parameters

 $V_{DS} = 28 \text{ V}; I_D = 50 \text{ mA}; \text{ note 1}$

f (MHz)		S ₁₁	S	21	S	12	s	22
(WIF12)	s ₁₁	∠Φ	s ₂₁	∠Φ	s ₁₂	∠Φ	s ₂₂	∠Φ
5	0.83	-91.4	23.64	124.0	0.05	34.6	0.79	-88.1
10	0.75	-125.6	13.95	103.2	0.05	14.4	0.69	-122.2
20	0.73	-147.1	7.17	84.8	0.06	-2.7	0.68	-143.6
30	0.75	-154.3	4.64	73.4	0.05	-12.7	0.70	-150.6
40	0.78	-157.9	3.30	64.6	0.05	-20.1	0.73	-154.2
50	0.80	-160.3	2.48	57.5	0.04	-25.9	0.77	-156.7
60	0.83	-162.2	1.94	51.4	0.04	-30.5	0.80	-158.9
70	0.86	-164.1	1.56	46.1	0.04	-34.1	0.83	-160.8
80	0.88	-165.8	1.27	41.4	0.03	-36.8	0.85	-162.7
90	0.89	-167.3	1.06	37.6	0.03	-38.6	0.87	-164.3
100	0.91	-168.6	0.89	34.2	0.02	-39.6	0.89	-165.9
125	0.93	-171.7	0.62	27.1	0.02	-37.1	0.92	-169.3
150	0.95	-174.2	0.45	22.3	0.01	-20.7	0.94	-172.1
175	0.96	-176.6	0.34	19.3	0.01	24.3	0.95	-174.6
200	0.97	-178.3	0.27	17.4	0.01	62.3	0.96	-176.7
250	0.98	178.3	0.18	16.1	0.02	81.9	0.97	179.7
300	0.98	175.4	0.13	19.5	0.03	85.4	0.98	176.8
350	0.98	172.6	0.10	24.8	0.04	86.0	0.98	174.1
400	0.98	170.3	0.09	33.5	0.05	85.6	0.98	171.6
450	0.98	167.9	0.08	41.5	0.06	85.3	0.98	169.2
500	0.98	165.6	0.08	49.6	0.06	83.9	0.98	166.9
600	0.98	161.1	0.09	61.3	0.08	81.9	0.98	162.5
700	0.98	156.7	0.10	66.5	0.10	79.6	0.98	158.0
800	0.97	152.0	0.12	69.1	0.12	78.2	0.97	153.7
900	0.97	147.0	0.14	69.5	0.13	76.0	0.97	149.3
1000	0.96	142.0	0.16	70.1	0.16	74.3	0.97	144.8

Note

^{1.} For more extensive S-parameters see internet: http://www.semiconductors.philips.com.markets/communications/wirelesscommunicationms/broadcast.

VHF power MOS transistor

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BLF246 scattering parameters

 $V_{DS} = 28 \text{ V}; I_D = 100 \text{ mA}; \text{note 1}$

f (MHz)		S ₁₁	S	21	S	12	s	22
1 (WIF12)	s ₁₁	∠Φ	s ₂₁	∠Φ	s ₁₂	∠Φ	s ₂₂	∠Φ
5	0.81	-113.3	30.83	116.1	0.04	26.8	0.77	-111.3
10	0.77	-142.3	17.04	99.5	0.04	11.1	0.72	-140.7
20	0.76	-158.6	8.64	85.7	0.04	-0.8	0.71	-156.6
30	0.77	-163.5	5.67	77.3	0.04	-7.7	0.72	-161.5
40	0.79	-165.8	4.12	70.5	0.04	-12.7	0.74	-163.3
50	0.80	-167.2	3.18	64.6	0.03	-16.7	0.76	-164.5
60	0.82	-168.2	2.54	59.3	0.03	-19.9	0.78	-165.4
70	0.84	-169.2	2.08	54.5	0.03	-22.4	0.80	-166.3
80	0.85	-170.0	1.74	50.4	0.03	-24.0	0.82	-167.1
90	0.87	-170.9	1.48	46.6	0.02	-24.9	0.84	-168.0
100	0.88	-171.8	1.27	43.0	0.02	-25.1	0.86	-169.0
125	0.90	-173.9	0.90	35.4	0.02	-20.6	0.89	-171.3
150	0.92	-175.9	0.67	29.8	0.01	-5.0	0.91	-173.3
175	0.94	-177.8	0.51	26.0	0.01	24.7	0.93	-175.2
200	0.95	-179.6	0.41	22.7	0.01	52.6	0.94	-177.1
250	0.96	177.3	0.27	18.6	0.02	76.2	0.96	179.7
300	0.97	174.4	0.20	17.8	0.03	82.2	0.97	176.9
350	0.97	171.7	0.15	19.4	0.03	84.2	0.97	174.3
400	0.97	169.2	0.13	23.4	0.04	84.3	0.98	171.9
450	0.97	166.7	0.11	28.4	0.05	84.6	0.98	169.6
500	0.97	164.3	0.10	34.9	0.06	83.3	0.98	167.4
600	0.97	159.5	0.09	46.8	0.07	81.6	0.98	163.1
700	0.96	154.5	0.10	55.1	0.09	79.5	0.98	158.8
800	0.96	149.3	0.11	61.0	0.10	78.8	0.98	154.5
900	0.95	143.6	0.12	63.0	0.11	76.3	0.97	150.0
1000	0.92	136.3	0.12	67.1	0.12	78.0	0.97	145.2

Note

^{1.} For more extensive S-parameters see internet: http://www.semiconductors.philips.com.markets/communications/wirelesscommunicationms/broadcast.

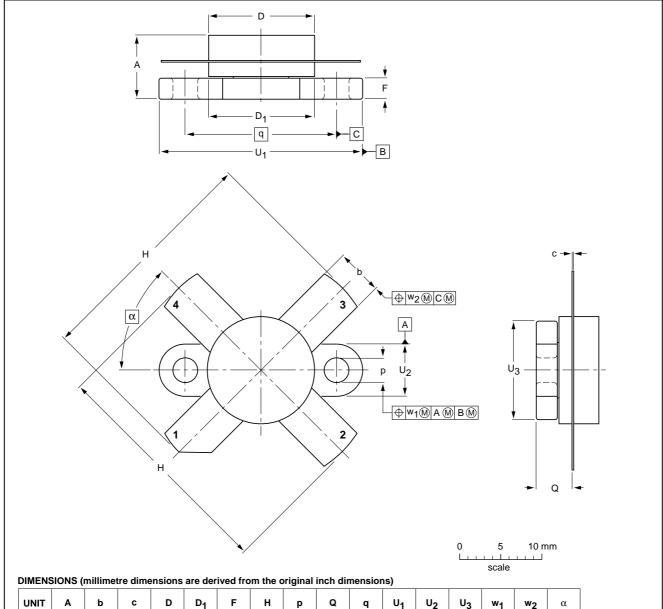
VHF power MOS transistor

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PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 4 leads

SOT121B



UNIT	Α	b	С	D	D ₁	F	Н	р	Q	q	U ₁	U ₂	U ₃	w ₁	w ₂	α
mm	7.27 6.17	5.82 5.56	0.16 0.10		12.83 12.57		28.45 25.52		4.45 3.91	18.42	24.90 24.63	6.48 6.22	12.32 12.06	0.25	0.51	45°
inches	0.286 0.243		0.006 0.004	0.506 0.496	0.505 0.495	0.105 0.095	1.120 1.005	0.130 0.120	0.175 0.154	0.725	0.98 0.97		0.485 0.475	0.01	0.02	45*

OUTLINE		EUROPEAN	ICCUE DATE			
VERSION	IEC	JEDEC EIAJ		PROJECTION	ISSUE DATE	
SOT121B					99-03-29	

VHF power MOS transistor

BLF246

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Philips Semiconductors – a worldwide company

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